



## IR Receiver Modules for Remote Control Systems



22911

### DESCRIPTION

This IR receiver series is optimized for long burst remote control systems in different environments. The customer can choose between different IC settings (AGC variants), to find the optimum solution for his application. The higher the AGC, the better noise is suppressed, but the lower the code compatibility.

The devices contain a PIN diode and a preamplifier assembled on a lead frame. The epoxy package contains an IR filter. The demodulated output signal can be directly connected to a microprocessor for decoding. These components have not been qualified to automotive specifications.

### FEATURES

- Individual IC settings to reach maximum performance
- Immunity against noise (lamps, LCD TV, Wi-Fi)
- Low supply current
- Photo detector and preamplifier in one package
- Supply voltage: 2.0 V to 5.5 V
- Material categorization:  
for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**  
**GREEN**  
(5-2008)

### LINKS TO ADDITIONAL RESOURCES



Product Page



Marking



Holders



Bends and Cuts

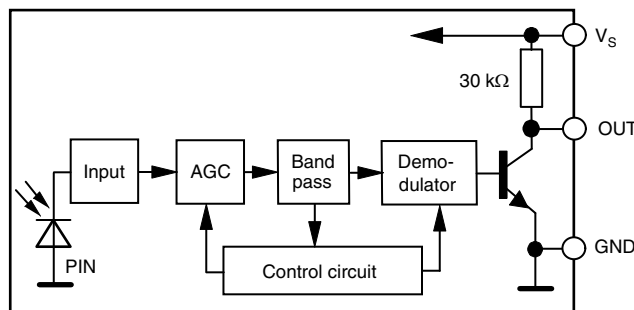
### APPLICATIONS

- Infrared remote control systems

### DESIGN SUPPORT TOOLS

- [3D models](#)
- [Window size calculator](#)

### BLOCK DIAGRAM



16833-22



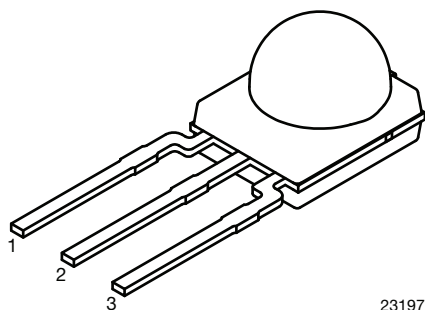
# TSOP132..DF1P, TSOP134..DF1P, TSOP136..DF1P

Vishay Semiconductors

## MECHANICAL DATA

### Pinning for TSOP13...DF1P:

1 = OUT, 2 = GND, 3 =  $V_S$

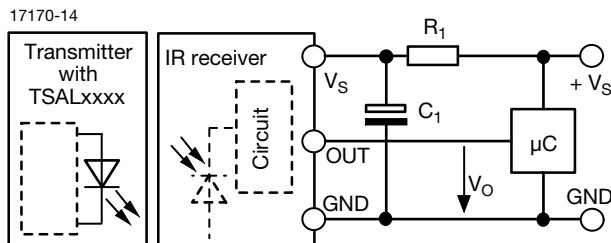


23197

## ORDERING CODE

TSOP13...DF1P - 1100 pieces in tape and reel

## APPLICATION CIRCUIT



$R_1$  and  $C_1$  recommended in case there are strong ripple or spikes on the supply line.

## PARTS TABLE

AGC		BASIC NOISE SUPPRESSION (AGC2)	ENHANCED NOISE SUPPRESSION (AGC4)	MAXIMIZED NOISE SUPPRESSION (AGC6)
Carrier frequency	30 kHz	TSOP13230DF1P	TSOP13430DF1P	TSOP13630DF1P
	33 kHz	TSOP13233DF1P	TSOP13433DF1P	TSOP13633DF1P
	36 kHz	TSOP13236DF1P	TSOP13436DF1P (4)(6)	TSOP13636DF1P (5)
	38 kHz	TSOP13238DF1P	TSOP13438DF1P (2)(3)(9)(10)	TSOP13638DF1P
	40 kHz	TSOP13240DF1P (11)	TSOP13440DF1P	TSOP13640DF1P
	56 kHz	TSOP13256DF1P (1)	TSOP13456DF1P (8)	TSOP13656DF1P (7)
Package		Minimold		
Pinning		1 = OUT, 2 = GND, 3 = $V_S$		
Dimensions (mm)		5.4 W x 6.35 H x 4.9 D		
Mounting		Leaded		
Application		Remote control		
Best choice for		(1) Cisco (2) Mitsubishi (3) NEC (4) Panasonic (5) RC-5 (6) RC-6 (7) RCA (8) r-step (9) Sejin 4PPM (10) Sharp (11) Sony		
Special options		<ul style="list-style-type: none"> <li>Narrow optical filter: <a href="http://www.vishay.com/doc?81590">www.vishay.com/doc?81590</a></li> <li>Wide optical filter: <a href="http://www.vishay.com/doc?82726">www.vishay.com/doc?82726</a></li> </ul>		

## ABSOLUTE MAXIMUM RATINGS

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Supply voltage		$V_S$	-0.3 to +6	V
Supply current		$I_S$	3	mA
Output voltage		$V_O$	-0.3 to ( $V_S + 0.3$ )	V
Output current		$I_O$	5	mA
Junction temperature		$T_j$	100	°C
Storage temperature range		$T_{stg}$	-25 to +85	°C
Operating temperature range		$T_{amb}$	-25 to +85	°C
Power consumption	$T_{amb} \leq 85^\circ\text{C}$	$P_{tot}$	10	mW
Soldering temperature	$t \leq 10\text{ s}, 1\text{ mm from case}$	$T_{sd}$	260	°C

### Note

- Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability



ELECTRICAL AND OPTICAL CHARACTERISTICS ( $T_{amb} = 25^{\circ}\text{C}$ , unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply current	$E_v = 0$ , $V_S = 3.3\text{ V}$	$I_{SD}$	0.25	0.35	0.45	mA
	$E_v = 40\text{ klx}$ , sunlight	$I_{SH}$	-	0.45	-	mA
Supply voltage		$V_S$	2.0	-	5.5	V
Transmission distance	$E_v = 0$ , test signal see Fig. 1, IR diode TSAL6200, $I_F = 50\text{ mA}$	$d$	-	39	-	m
Output voltage low	$I_{OSL} = 0.5\text{ mA}$ , $E_e = 0.7\text{ mW/m}^2$ , test signal see Fig. 1	$V_{OSL}$	-	-	100	mV
Minimum irradiance	Test signal: RC5 code	$E_e\text{ min.}$	-	0.05	0.1	$\text{mW/m}^2$
	Test signal: NEC code	$E_e\text{ min.}$	-	0.1	0.2	$\text{mW/m}^2$
Maximum irradiance	$t_{pi} - 5/f_0 < t_{po} < t_{pi} + 5/f_0$ , test signal see Fig. 1	$E_e\text{ max.}$	30	-	-	$\text{W/m}^2$
Directivity	Angle of half transmission distance	$\Phi_{1/2}$	-	$\pm 45$	-	$^{\circ}$

### TYPICAL CHARACTERISTICS ( $T_{amb} = 25^{\circ}\text{C}$ , unless otherwise specified)

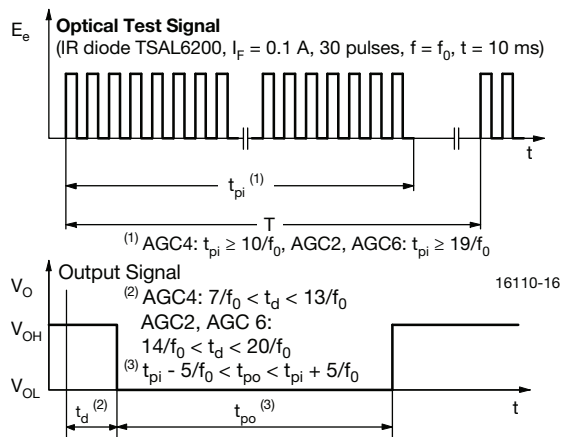


Fig. 1 - Output Delay and Pulse-Width

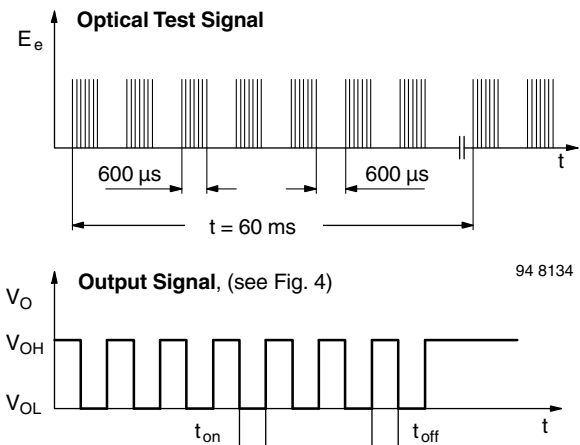


Fig. 3 - Test Signal

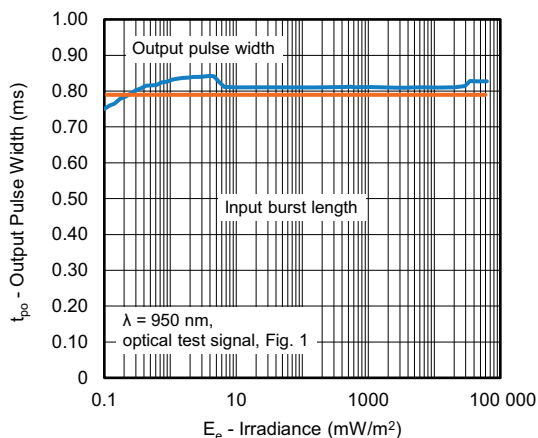


Fig. 2 - Pulse-Width vs. Irradiance in Dark Ambient

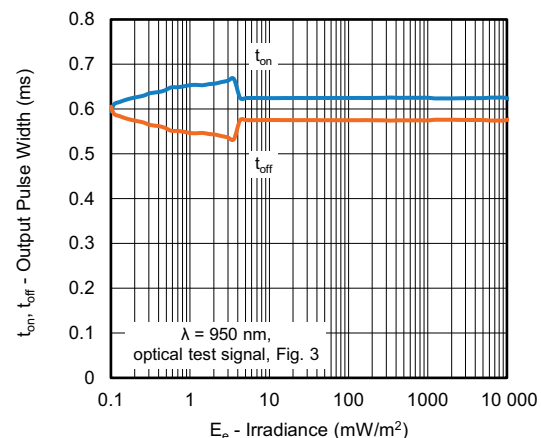


Fig. 4 - Pulse-Width vs. Irradiance in Dark Ambient

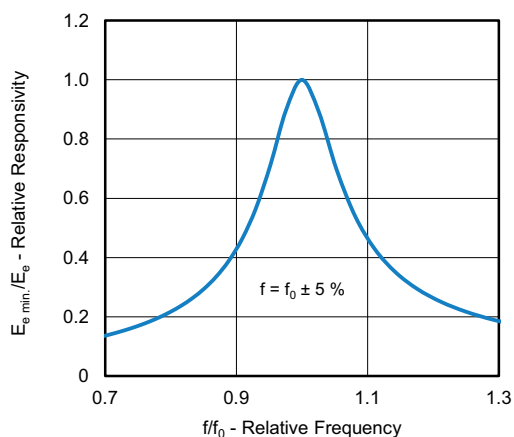


Fig. 5 - Frequency Dependence of Responsivity

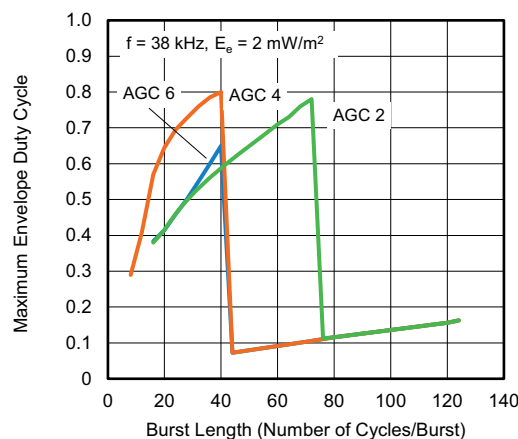


Fig. 8 - Max. Envelope Duty Cycle vs. Burst Length

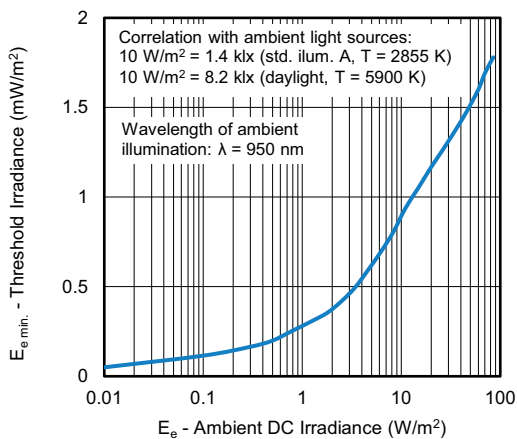


Fig. 6 - Sensitivity in Bright Ambient

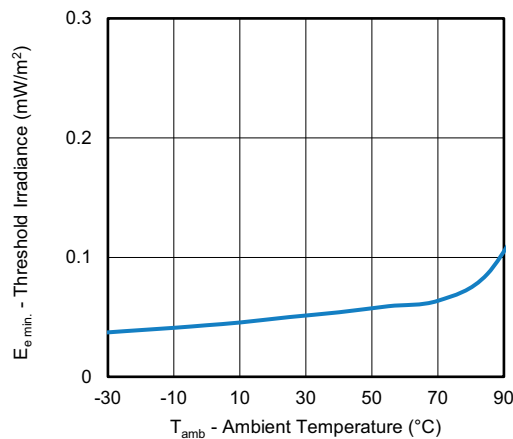


Fig. 9 - Sensitivity vs. Ambient Temperature

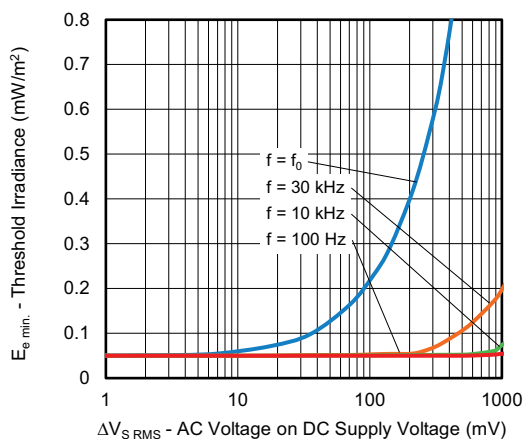


Fig. 7 - Sensitivity vs. Supply Voltage Disturbances

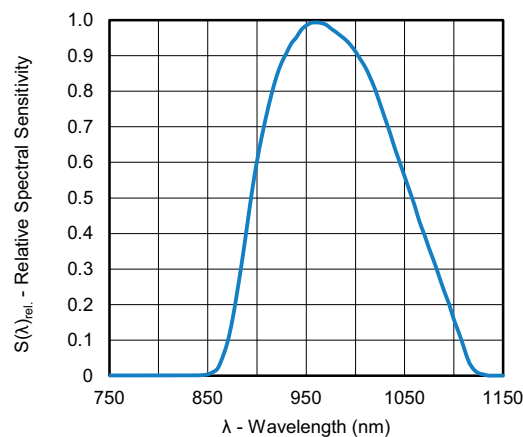
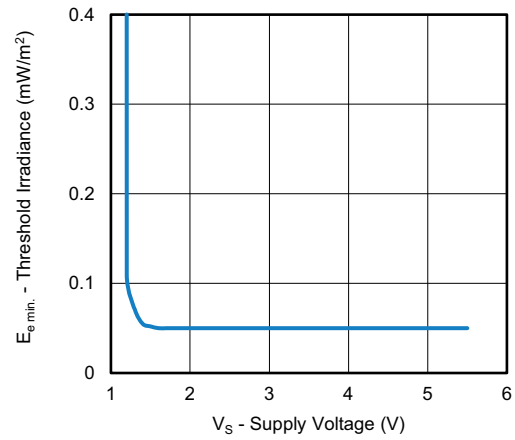
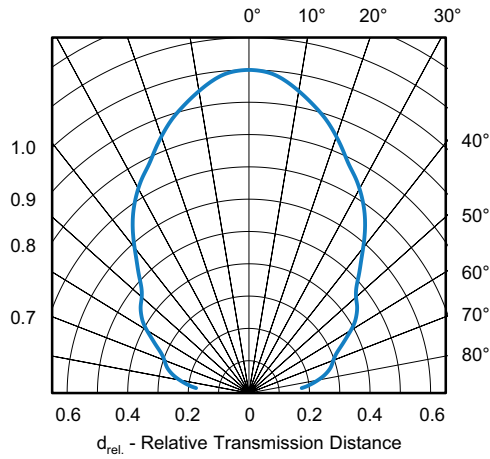


Fig. 10 - Relative Spectral Sensitivity vs. Wavelength





## SUITABLE DATA FORMAT

This series is designed to suppress spurious output pulses due to noise or disturbance signals. The devices can distinguish data signals from noise due to differences in frequency, burst length, and envelope duty cycle. The data signal should be close to the device's band-pass center frequency (e.g. 38 kHz) and fulfill the conditions in the table below.

When a data signal is applied to the product in the presence of a disturbance, the sensitivity of the receiver is automatically reduced by the AGC to insure that no spurious pulses are present at the receiver's output. Some examples which are suppressed are:

- DC light (e.g. from tungsten bulbs sunlight)
- Continuous signals at any frequency
- Strongly or weakly modulated patterns from fluorescent lamps with electronic ballasts (see Fig. 13 or Fig. 14)
- 2.4 GHz and 5 GHz Wi-Fi

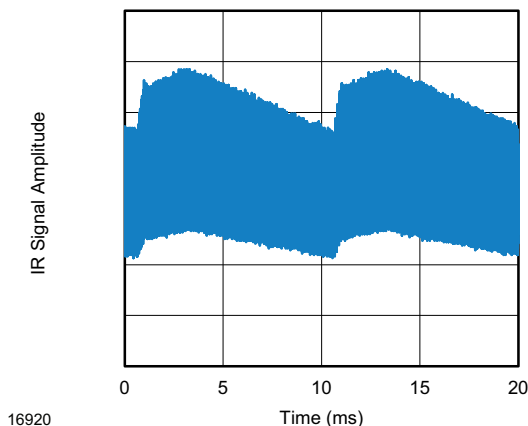


Fig. 13 - IR Emission from Fluorescent Lamp With Low Modulation

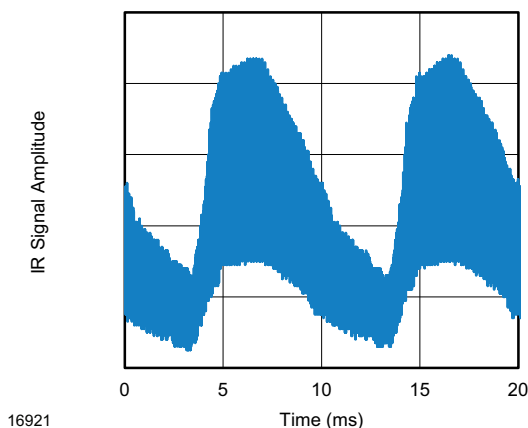


Fig. 14 - IR Emission from Fluorescent Lamp With High Modulation

	TSOP132..DF1P	TSOP134..DF1P	TSOP136..DF1P
Minimum burst length	19 cycles/burst	10 cycles/burst	19 cycles/burst
After each burst of length a minimum gap time is required of	19 to 72 cycles ≥ 20 cycles	10 to 40 cycles ≥ 11 cycles	19 to 40 cycles ≥ 20 cycles
For bursts greater than a minimum gap time in the data stream is needed of	72 cycles > 6 x burst length	40 cycles > 10 x burst length	40 cycles > 10 x burst length
Maximum number of continuous short bursts/second	750	1300	750
RC-5 code	Yes	Yes	Preferred
RC-6 code	No	Preferred	No
NEC code	Yes	Preferred	Yes
r-step code	No	Preferred	No
Sony code	Preferred	No	No
RCA 56 kHz code	Yes	Yes	Preferred
Suppression of interference from fluorescent lamps	Fig. 13	Fig. 13 and Fig. 14	Fig. 13 and Fig. 14

### Note

- For data formats with short bursts please see the datasheet for TSOP131..DF1P, TSOP133..DF1P, TSOP135..DF1P

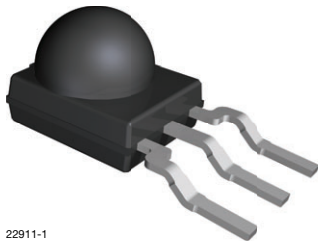


www.vishay.com

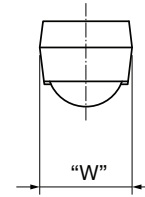
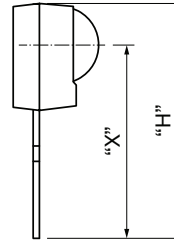
# TSOP132..DF1P, TSOP134..DF1P, TSOP136..DF1P

Vishay Semiconductors

**BENT LEADS: H = 11.4 mm, W = 5.4 mm, X = 8.85 mm**



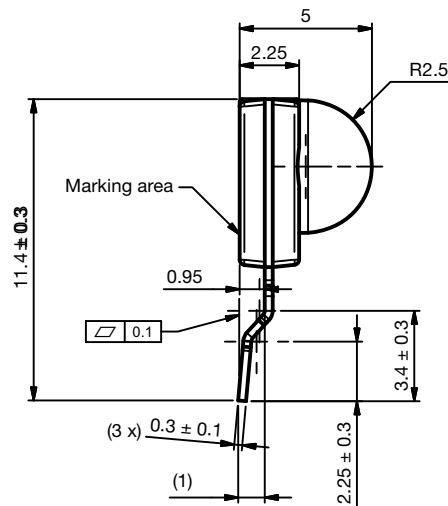
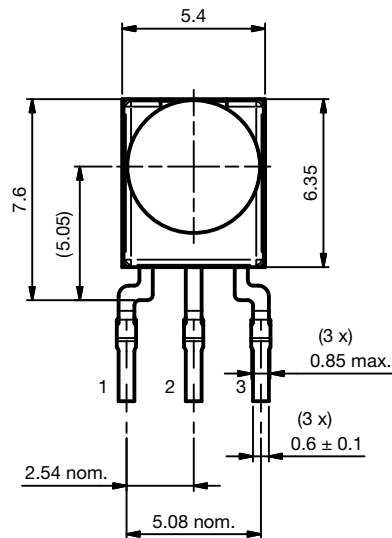
22911-1



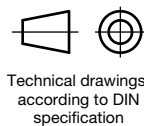
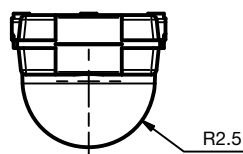
20258

NAME	LENS AXIS (X)	VIEW	TYPE	HEIGHT (H)	WIDTH (W)	DEPTH (D)
DF1P	8.85	-	Bend	11.4	5.4	-

## MECHANICAL DIMENSIONS in millimeters

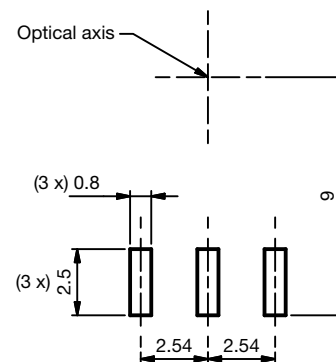


Not indicated tolerances  $\pm 0.2$



Technical drawings according to DIN specification

Proposed pad layout from component side (for reference only)



Drawing-No.: 6.550-5343.01-4  
Issue: 2; 02.07.19



## ASSEMBLY INSTRUCTIONS

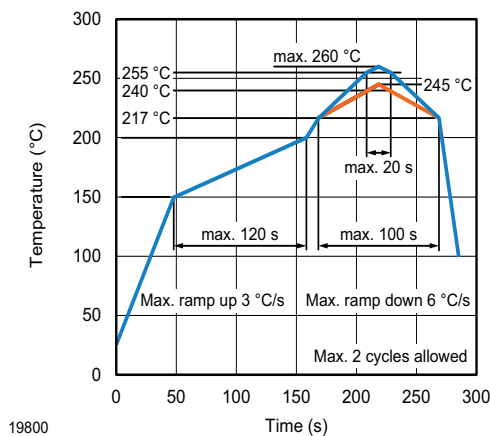
### Reflow Soldering

- Reflow soldering must be done within 72 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

### Manual Soldering

- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- Finish soldering within 3 s
- Handle products only after the temperature has cooled off

## VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE



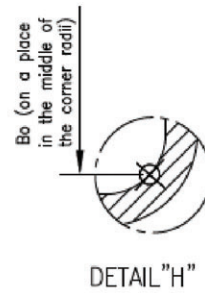
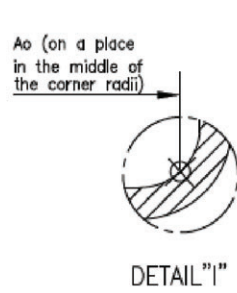
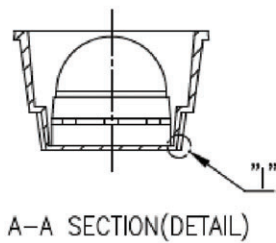
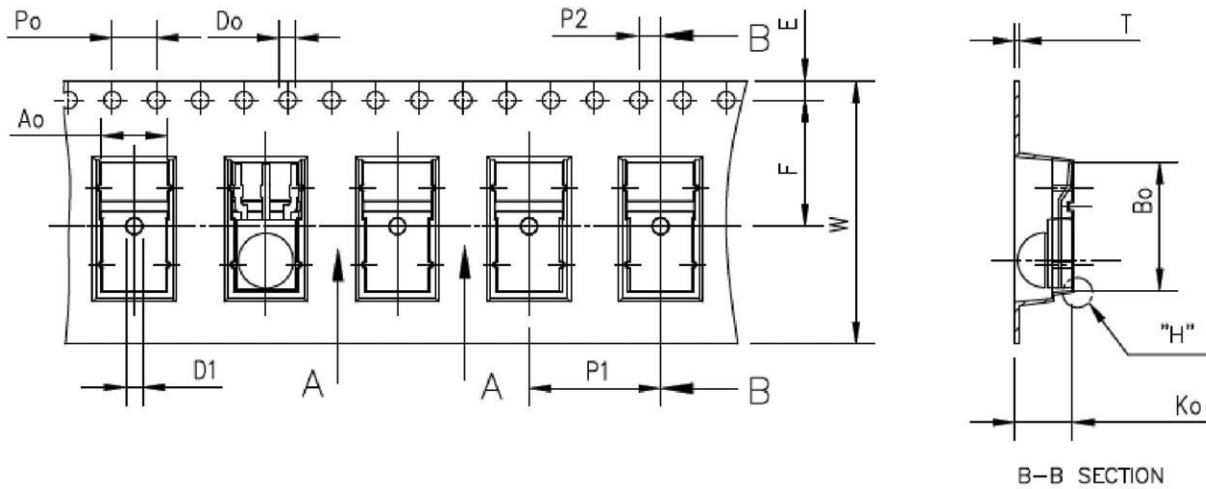


[www.vishay.com](http://www.vishay.com)

# TSOP132..DF1P, TSOP134..DF1P, TSOP136..DF1P

Vishay Semiconductors

## PACKAGING DIMENSIONS in millimeters

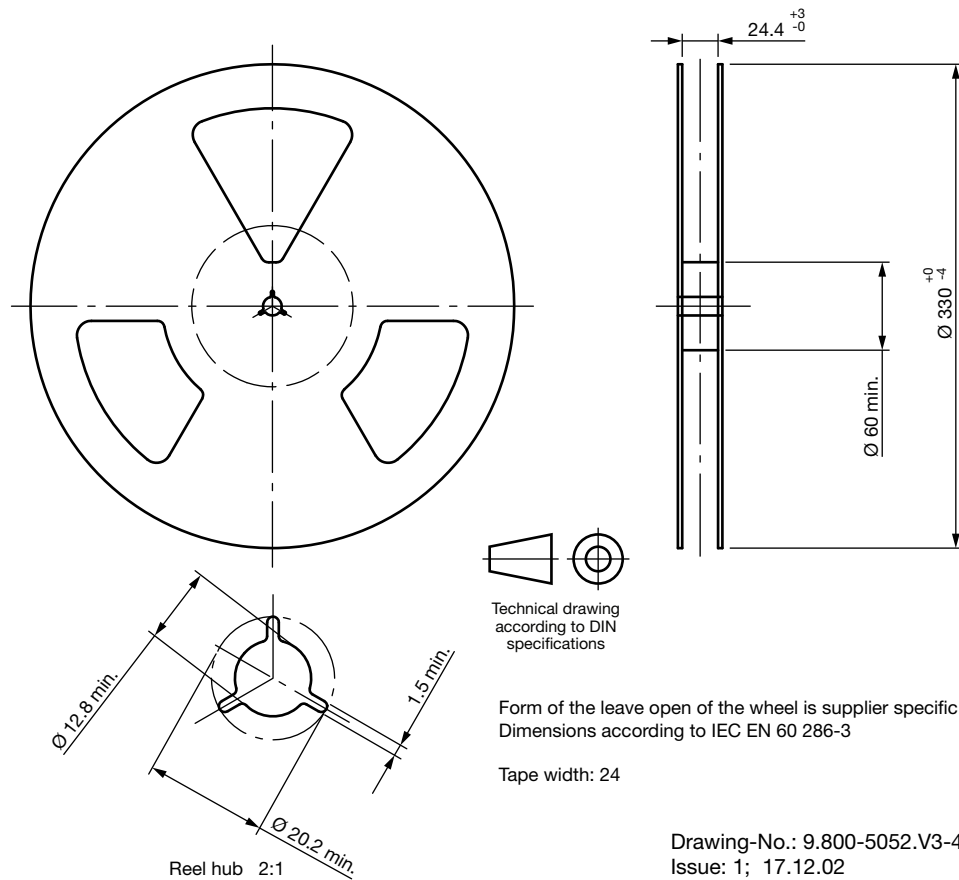


Drawing-No.: 9.700-5399.01-4  
Issue: 2; 29.06.18

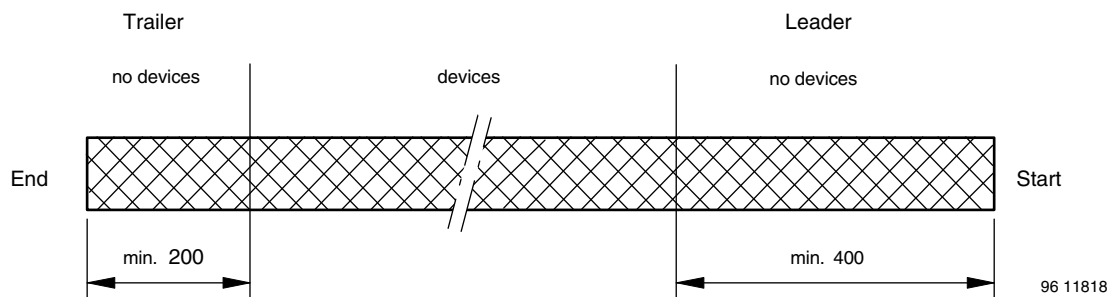
Item	$A_0$	$B_0$	$K_0$	$P_0$	$P_1$	$P_2$	$T$
Dimensions	$6.08 \pm 0.10$	$11.75 \pm 0.10$	$5.25 \pm 0.10$	$4.0 \pm 0.10$	$12.0 \pm 0.10$	$2.0 \pm 0.10$	$0.40 \pm 0.05$
Item	$E$	$F$	$D_0$	$D_1$	$W$	$10P_0$	
Dimensions	$1.75 \pm 0.10$	$11.50 \pm 0.10$	$1.55 \pm 0.05$	1.5 min.	$24.0 +0.30 / -0.10$	$40.0 \pm 0.20$	



**REEL DIMENSIONS** in millimeters



**LEADER AND TRAILER DIMENSIONS** in millimeters



**COVER TAPE PEEL STRENGTH**

According to DIN EN 60286-3

0.1 N to 1.3 N

300 mm/min.  $\pm 10 \text{ mm/min.}$

165° to 180° peel angle

**ORDERING INFORMATION****Note**

- d = "digit", please consult the list of available series on the previous page to create a valid part number

**Example: TSOP13238DF1P****PACKAGING QUANTITY**

- 1100 pieces per reel
- 1 reel per box

**LABEL****Standard bar code labels for finished goods**

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

<b>VISHAY SEMICONDUCTOR GmbH STANDARD BAR CODE PRODUCT LABEL (finished goods)</b>		
<b>PLAIN WRITING</b>	<b>ABBREVIATION</b>	<b>LENGTH</b>
Item-description	-	18
Item-number	INO	8
Selection-code	SEL	3
LOT-/serial-number	BATCH	10
Data-code	COD	3 (YWW)
Plant-code	PTC	2
Quantity	QTY	8
Accepted by	ACC	-
Packed by	PCK	-
Mixed code indicator	MIXED CODE	-
Origin	xxxxxxx+	Company logo
<b>LONG BAR CODE TOP</b>	<b>TYPE</b>	<b>LENGTH</b>
Item-number	N	8
Plant-code	N	2
Sequence-number	X	3
Quantity	N	8
Total length	-	21
<b>SHORT BAR CODE BOTTOM</b>	<b>TYPE</b>	<b>LENGTH</b>
Selection-code	X	3
Data-code	N	3
Batch-number	X	10
Filter	-	1
Total length	-	17



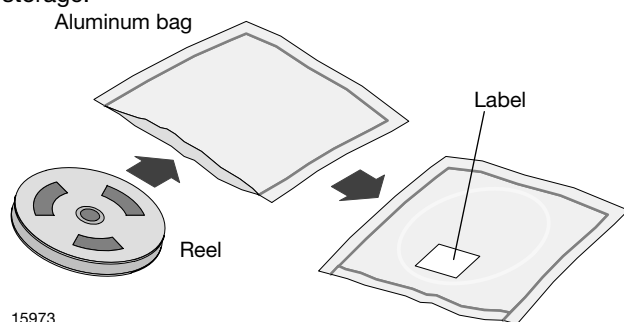
www.vishay.com

# TSOP132..DF1P, TSOP134..DF1P, TSOP136..DF1P

Vishay Semiconductors

## DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



15973

## FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

## RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

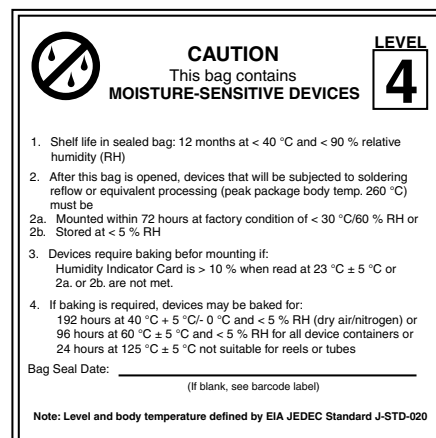
- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or  
96 h at 60 °C + 5 °C and < 5 % RH for all device containers or  
24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC® standard J-STD-020 level 4 label is included on all dry bags.



22522

EIA JEDEC standard J-STD-020 level 4 label is included on all dry bags

## ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

## VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



22645



## Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Vishay products are not designed for use in life-saving or life-sustaining applications or any application in which the failure of the Vishay product could result in personal injury or death unless specifically qualified in writing by Vishay. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.